



Vertrieb und Produktinformation:  
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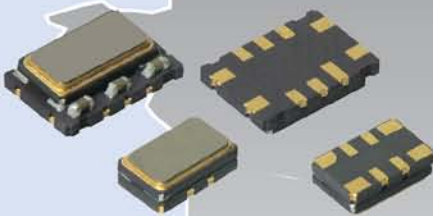
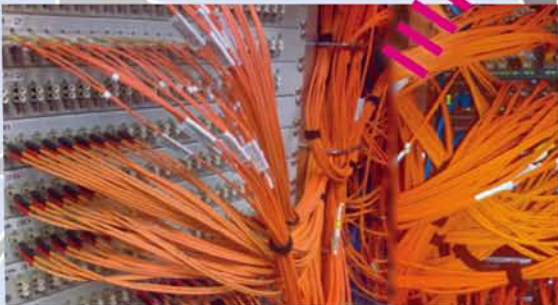
QuartzCom  
the communications company

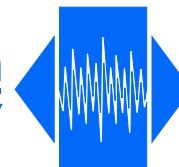


**TCXO** High Precision Analogue Compensated Crystal Oscillators

**for STRATUM III, IEEE 1588v2**

Synchronization of TDM Networks, SDH/SONET, Metro Ethernet, Fibre Channel, Wireless Communications, Wireless Backhaul





## for network synchronization

<b>Applications</b>	<ul style="list-style-type: none"> <li>• TDM networks, SONET / SDH, Metro Ethernet</li> <li>• Wireless backhaul</li> <li>• Wireless communications, picocells, femtocells</li> <li>• STRATUM III, Synchronous Ethernet, IEEE 1588 v2, SETS</li> </ul>
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<b>Features</b>	<ul style="list-style-type: none"> <li>• Holdover stability: <math>\pm 0.37</math> ppm over 24 h</li> <li>• Overall stability: <math>\pm 4.60</math> ppm including 20 years aging</li> <li>• Short term aging, G.813 Option 1: <math>\pm 0.01</math> ppm over 24 h @ +25 °C</li> </ul>
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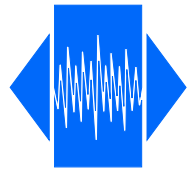
<b>Standard frequencies</b>	<b>10.0, 12.80, 16.3840, 19.440, 20.0, 21.350 25.0, 32.0, 38.880 &amp; 40.0 MHz</b>	
<b>Frequency range</b>	<b>5.0 ~ 52.0 MHz</b>	
<b>Frequency stability</b>	<b><math>\leq \pm 4.60</math> ppm</b>	<b>overall inclusive</b> (Note #1)
Overall inclusive	frequency stability vs. temperature, tolerance ex factory, aging over 20 years, supply & load variation	
Frequency stability vs. temperature	$\leq \pm 0.28$ ppm	over operating temperature range
Long term aging	$\leq \pm 3.0$ ppm	over 20 years
Holdover stability	$\leq \pm 0.37$ ppm	over 24 h (Note #2)
Short term aging, G.813 Option 1	$\leq \pm 0.01$ ppm/day	@ +25 °C $\pm 1$ °C (Note #3)
Frequency slope	$\leq 0.05$ ppm/°C	over operating temperature
Short term stability (ADEV)	$< 1 \times 10^{-10}$	@ $\tau = 1$ s
Frequency tolerance ex factory	$\leq \pm 0.50$ ppm	@ +25 °C
Supply voltage (Vdc)	+2.7 V to +5.0 V	nominal value needs to be defined, standard: 3.3 V and 5.0 V $\pm 5$ %
Supply current	< 3 mA < 8 mA	10 MHz ~ 20 MHz up to 52 MHz
Output signal	CMOS	(Note #4)
Output level	$V_{OH} > 0.9 \times V_{dc}$	$V_{OL} < 0.1 \times V_{dc}$
Output load	15 pF	
Symmetry (duty cycle)	45 / 55 %	@ $\frac{1}{2} V_{dc}$
Tri-state function	Input $\geq 0.7 \times V_{dc}$ or open Input $\leq 0.3 \times V_{dc}$ or GND	Output $\rightarrow$ oscillation Output $\rightarrow$ high impedance
Jitter (rms) $1\sigma$	< 0.5 ps	@ $F_j = 12$ kHz ~ 20 MHz
Phase noise @ 19.44 MHz	< -95 dBc/Hz < -125 dBc/Hz < -145 dBc/Hz < -155 dBc/Hz < -155 dBc/Hz	@ 10 Hz @ 100 Hz @ 1 kHz @ 10 kHz @ 100 kHz
Operating temperature range	-20 ~ +70 °C -40 ~ +85 °C	indoor outdoor
Storage temperature range	-55 ~ +125 °C	
Reflow Profiles as per IPC/JEDEC J-STD-020C	$\leq 260$ °C over 10 sec. Max.	
Moisture sensitivity	Level 1 (unlimited)	
Packing units	tape & reel	500 or 1000 pieces

Note #1: Including frequency stability vs. temperature, tolerance @ +25 °C, aging 20 years, supply & load variation

Note #2: Including frequency stability vs. temperature, supply change of  $\pm 1$  % and aging over 24 h

Note #3: 1 day = 24 h

Note #4: Clipped sine wave on request



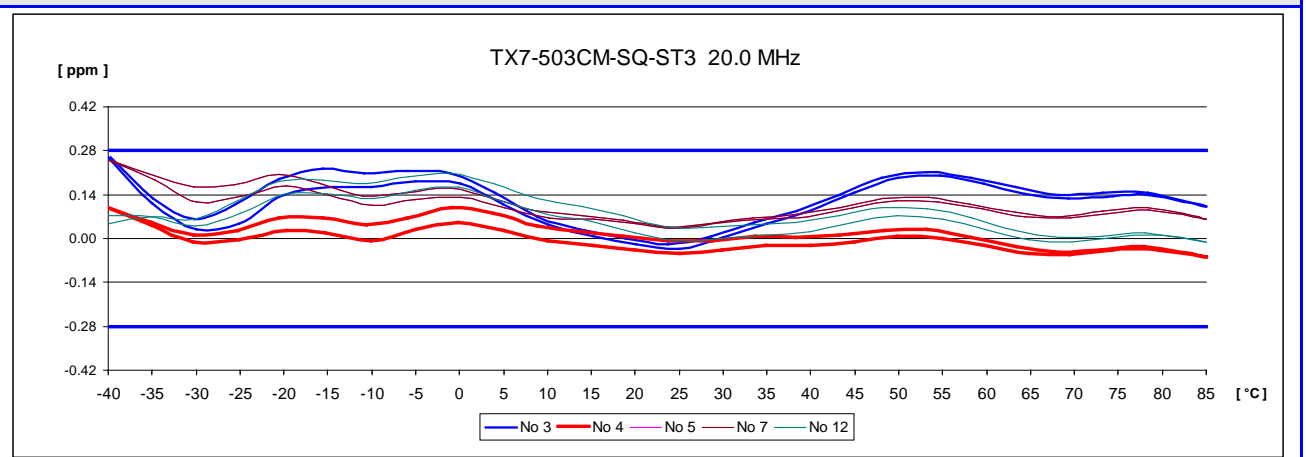
## for network synchronization

### Package outline and recommended solder pattern

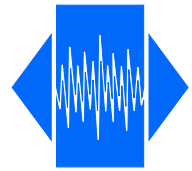
TX7-705CM-SQ-ST3	TX7-705CM-TQ-ST3
<p>Pin function</p> <ul style="list-style-type: none"> <li># 1 Do not connect</li> <li># 5 GND</li> <li># 6 Output</li> <li># 9 Tri-state</li> <li># 10 Vdc</li> </ul> <p>Do not connect: #2, #3, #4, #7 &amp; #8</p> <p>Solder pattern</p>	<p>Pin function</p> <ul style="list-style-type: none"> <li># 1 Do not connect</li> <li># 2 GND</li> <li># 3 Output</li> <li># 4 Vdc</li> </ul> <p>Solder pattern</p>

TX7-503CM-SQ-ST3	IR reflow soldering temperature
<p>Pin function</p> <ul style="list-style-type: none"> <li># 1 Do not connect</li> <li># 4 GND</li> <li># 5 Output</li> <li># 6 Tri-state</li> <li># 8 Vdc</li> </ul> <p>Do not connect: #2, #3 &amp; #7</p> <p>Solder pattern</p>	<p>1) Total CL incl. test-jig and active probe</p> <p>Active probe to Oscilloscope</p> <p>74LVC04</p> <p>CL 15 pF 1)</p> <p>RF-OUTPUT</p>

### Frequency hysteresis vs. temperature

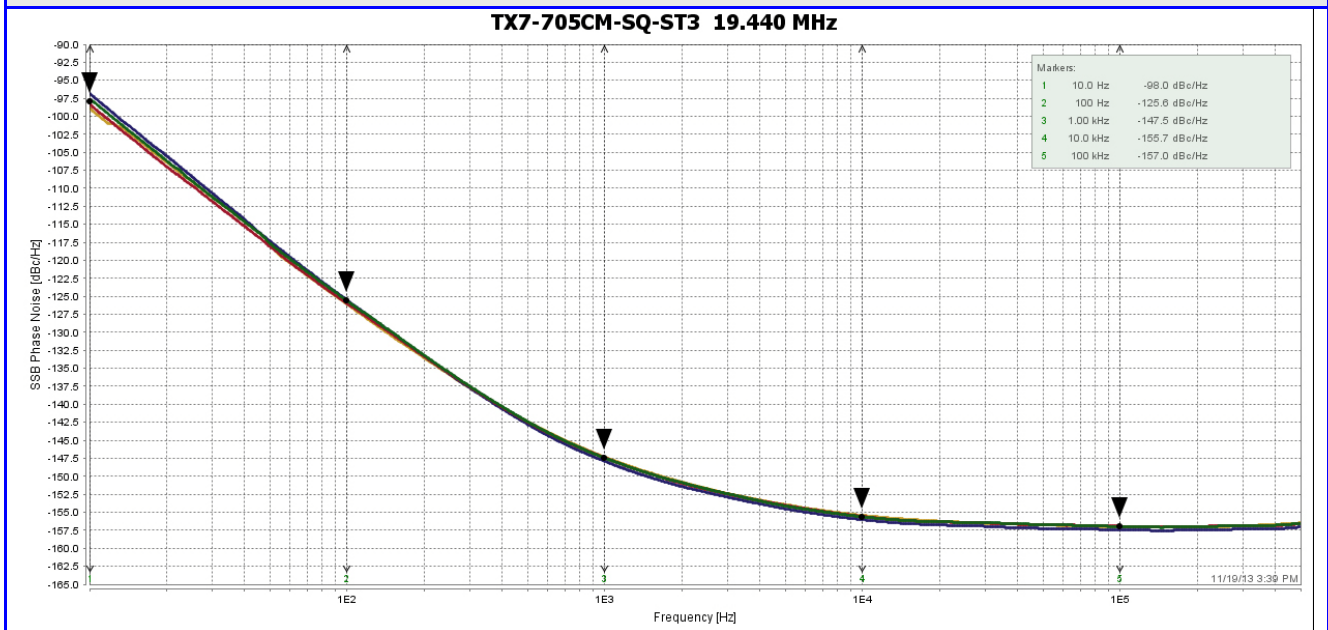






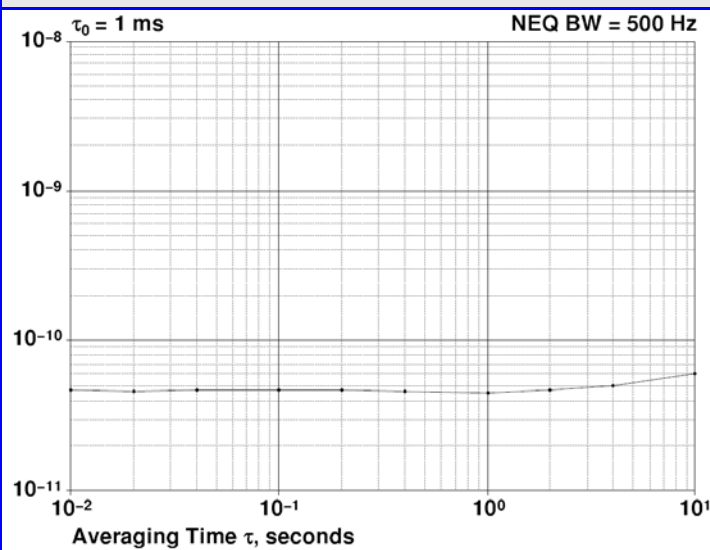
## for network synchronization

### Phase noise



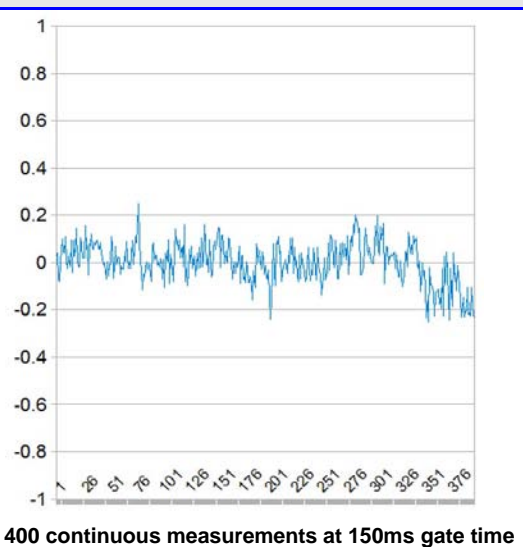
#11 ~ #14

### Short term stability (Allan deviation)



#11

### Frequency stability in ppb



Environmental	Reference STD.		Test condition
Vibration sinusoidal	IEC 60028-2-6	IEC 60679-1-5.6.7	Test Fc, 30 min per axis 10 Hz – 55 Hz with 0.75 mm, 55 Hz – 2 kHz with 10 g
Shock	IEC 60028-2-27	IEC 60679-1-5.6.8	Test Ea, 3 x per axis, 100 g, 6 ms half sine pulse
Solderability	IEC 60028-2-20 IEC 60028-2-58	IEC 60679-5.6.3	Test Ta (235 ±2) °C Method 1 Test Tb Method 1A, 5 s

*QuartzCom, more than frequency*

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